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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

Product Status	Active
Core Processor	RXv2
Core Size	32-Bit Single-Core
Speed	54MHz
Connectivity	I ² C, IrDA, SCI, SPI, SSI
Peripherals	DMA, LVD, POR, PWM, WDT
Number of I/O	47
Program Memory Size	128KB (128K x 8)
Program Memory Type	FLASH
EEPROM Size	8K x 8
RAM Size	32K x 8
Voltage - Supply (Vcc/Vdd)	1.8V ~ 5.5V
Data Converters	A/D 12x12b; D/A 2x12b
Oscillator Type	Internal
Operating Temperature	-40°C ~ 85°C (TA)
Mounting Type	Surface Mount
Package / Case	64-LQFP
Supplier Device Package	64-LFQFP (10x10)
Purchase URL	https://www.e-xfl.com/product-detail/renesas-electronics-america/r5f52305adfm-30

1.2 List of Products

Table 1.3 and Table 1.4 are a list of products, and Figure 1.1 shows how to read the product part no., memory capacity, and package type.

Table 1.3 List of Products: D Version (T_a = –40 to +85°C) (1/2)

Group	Part No.	Order Part No.	Package	ROM Capacity	RAM Capacity	E2 DataFlash	Operating Frequency	Security Function	SDHI	CAN	Operating Temperature
RX231	R5F52318ADLA	R5F52318ADLA#20	PTLG0100KA-A	512 Kbytes	64 Kbytes	8 Kbytes	54 MHz	Not available	Not available	Available	–40 to +85°C
	R5F52318BDLA	R5F52318BDLA#20						Available	Available	Available	
	R5F52318ADFP	R5F52318ADFP#30	PLQP0100KB-B					Not available	Not available	Available	
	R5F52318BDFP	R5F52318BDFP#30						Available	Available	Available	
	R5F52318ADND	R5F52318ADND#U0	PWQN0064KC-A					Not available	Not available	Available	
	R5F52318BDND	R5F52318BDND#U0						Available	Available	Available	
	R5F52318ADFM	R5F52318ADFM#30	PLQP0064KB-C					Not available	Not available	Available	
	R5F52318BDFM	R5F52318BDFM#30						Available	Available	Available	
	R5F52318ADNE	R5F52318ADNE#U0	PWQN0048KB-A					Not available	Not available	Available	
	R5F52318BDNE	R5F52318BDNE#U0						Available	Not available	Available	
	R5F52318ADFL	R5F52318ADFL#30	PLQP0048KB-B					Not available	Not available	Available	
	R5F52318BDFL	R5F52318BDFL#30						Available	Not available	Available	
	R5F52317ADLA	R5F52317ADLA#20	PTLG0100KA-A	384 Kbytes				Not available	Not available	Available	
	R5F52317BDLA	R5F52317BDLA#20						Available	Available	Available	
	R5F52317ADFP	R5F52317ADFP#30	PLQP0100KB-B					Not available	Not available	Available	
	R5F52317BDFP	R5F52317BDFP#30						Available	Available	Available	
	R5F52317ADND	R5F52317ADND#U0	PWQN0064KC-A					Not available	Not available	Available	
	R5F52317BDND	R5F52317BDND#U0						Available	Available	Available	
	R5F52317ADFM	R5F52317ADFM#30	PLQP0064KB-C					Not available	Not available	Available	
	R5F52317BDFM	R5F52317BDFM#30						Available	Available	Available	
	R5F52317ADNE	R5F52317ADNE#U0	PWQN0048KB-A					Not available	Not available	Available	
	R5F52317BDNE	R5F52317BDNE#U0						Available	Not available	Available	
	R5F52317ADFL	R5F52317ADFL#30	PLQP0048KB-B					Not available	Not available	Available	
	R5F52317BDFL	R5F52317BDFL#30						Available	Not available	Available	
	R5F52316ADLA	R5F52316ADLA#20	PTLG0100KA-A	256 Kbytes	32 Kbytes			Not available	Not available	Available	
	R5F52316CDLA	R5F52316CDLA#20						Not available	Not available	Not available	
	R5F52316ADFP	R5F52316ADFP#30	PLQP0100KB-B					Not available	Not available	Available	
	R5F52316CDFP	R5F52316CDFP#30						Not available	Not available	Not available	
	R5F52316CDLF	R5F52316CDLF#U0	PWL0064KA-A					Not available	Not available	Not available	
	R5F52316ADND	R5F52316ADND#U0	PWQN0064KC-A					Not available	Not available	Available	
	R5F52316CDND	R5F52316CDND#U0						Not available	Not available	Not available	
	R5F52316ADFM	R5F52316ADFM#30	PLQP0064KB-C					Not available	Not available	Available	
	R5F52316CDFM	R5F52316CDFM#30						Not available	Not available	Not available	
	R5F52316ADNE	R5F52316ADNE#U0	PWQN0048KB-A					Not available	Not available	Available	
	R5F52316CDNE	R5F52316CDNE#U0						Not available	Not available	Not available	

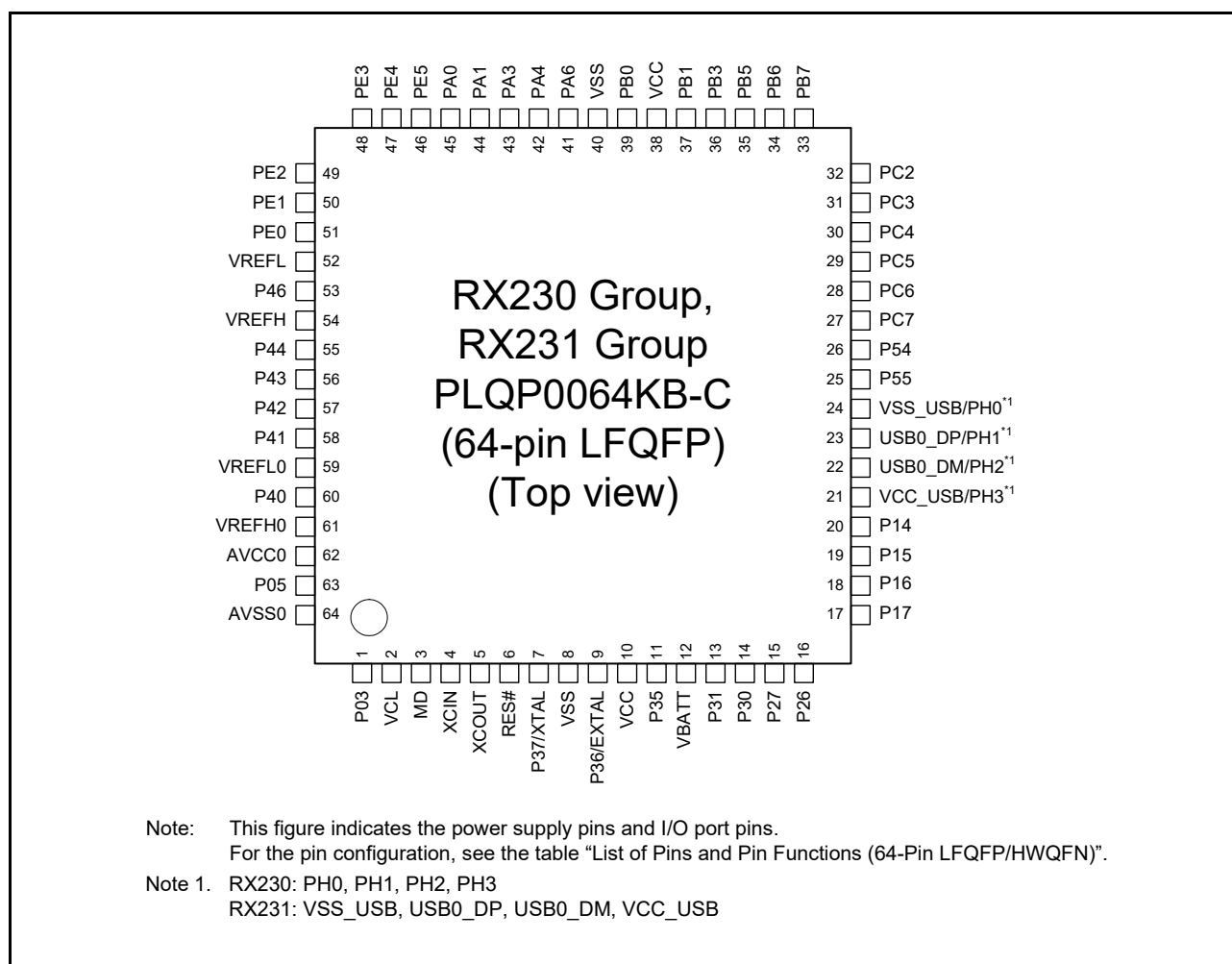
**Figure 1.7 Pin Assignments of the 64-Pin LFQFP**

Table 1.8 List of Pins and Pin Functions (64-Pin WFLGA) (2/2)

Pin No.	Power Supply, Clock, System Control	I/O Port	Timers (MTU, TPU, TMR, RTC, CMT, POE, CAC)	Communications (SCI, RSPI, RIIC, RSCAN, USB, SSI)	Memory Interface (SDHI)	Touch sensing	Others
F4		PC5	MTIOC3B/MTCLKD/TMRI2	SCK8/RSPCKA/USB0_ID			TS23
F5		P15	MTIOC0B/MTCLKB/TMC12/TIOCB2/TCLKB	RXD1/SMISO1/SSCL1/CRXD0		TS12	IRQ5/CMPB2
F6		PB1	MTIOC0C/MTIOC4C/TMC10/TIOCB3	TXD6/SMOSI6/SSDA6	SDHI_CLK		IRQ4/CMPOB1
F7		PB5	MTIOC2A/MTIOC1B/TMRI1/POE1#/TIOCB4	SCK9/USB0_VBUS	SDHI_CD		
F8		PB3	MTIOC0A/MTIOC4A/TMO0/POE3#/TIOC3D/TCLKD	SCK6	SDHI_WP		
G1	EXTAL	P36					
G2		P26	MTIOC2A/TMO1	TXD1/SMOSI1/SSDA1/USB0_VBUSEN/SSIRXD0		TS3	CMPB3
G3	VCC_USB*1	PH3*1	TMC10*1				
G4	VSS_USB*1	PH0*1					CACREF*1
G5	UB	PC7	MTIOC3A/MTCLKB/TMO2	TXD8/SMOSI8/SSDA8/MISOA			CACREF
G6		PC6	MTIOC3C/MTCLKA/TMC12	RXD8/SMISO8/SSCL8/MOSIA/USB0_EXICEN		TS22	
G7		PC3	MTIOC4D/TCLKB	TXD5/SMOSI5/SSDA5/IRTXD5	SDHI_D0	TS27	
G8		PB6/PC0	MTIOC3D/TIOCA5	RXD9/SMISO9/SSCL9	SDHI_D1		
H1	XTAL	P37					
H2		P17	MTIOC3A/MTIOC3B/TMO1/POE8#/TIOCB0/TCLKD	SCK1/MISOA/SDA/SSITXD0			IRQ7/CMPOB2
H3		PH2*1	TMRI0*1	USB0_DM*1			IRQ1*1
H4		PH1*1	TMO0*1	USB0_DP*1			IRQ0*1
H5		P55	MTIOC4D/TMO3	CRXD0		TS15	
H6		P54	MTIOC4B/TMC11	CTXD0		TS16	
H7		PC2	MTIOC4B/TCLKA	RXD5/SMISO5/SSCL5/SSLA3/IRRXD5	SDHI_D3	TS30	
H8		PB7/PC1	MTIOC3B/TIOCB5	TXD9/SMOSI9/SSDA9	SDHI_D2		

Note 1. RX230: PH0/CACREF, PH1/IRQ0/TMO0, PH2/IRQ1/TMRI0, PH3/TMC10
RX231: VSS_USB, USB0_DP, USB0_DM, VCC_USB

2. CPU

Figure 2.1 shows register set of the CPU.

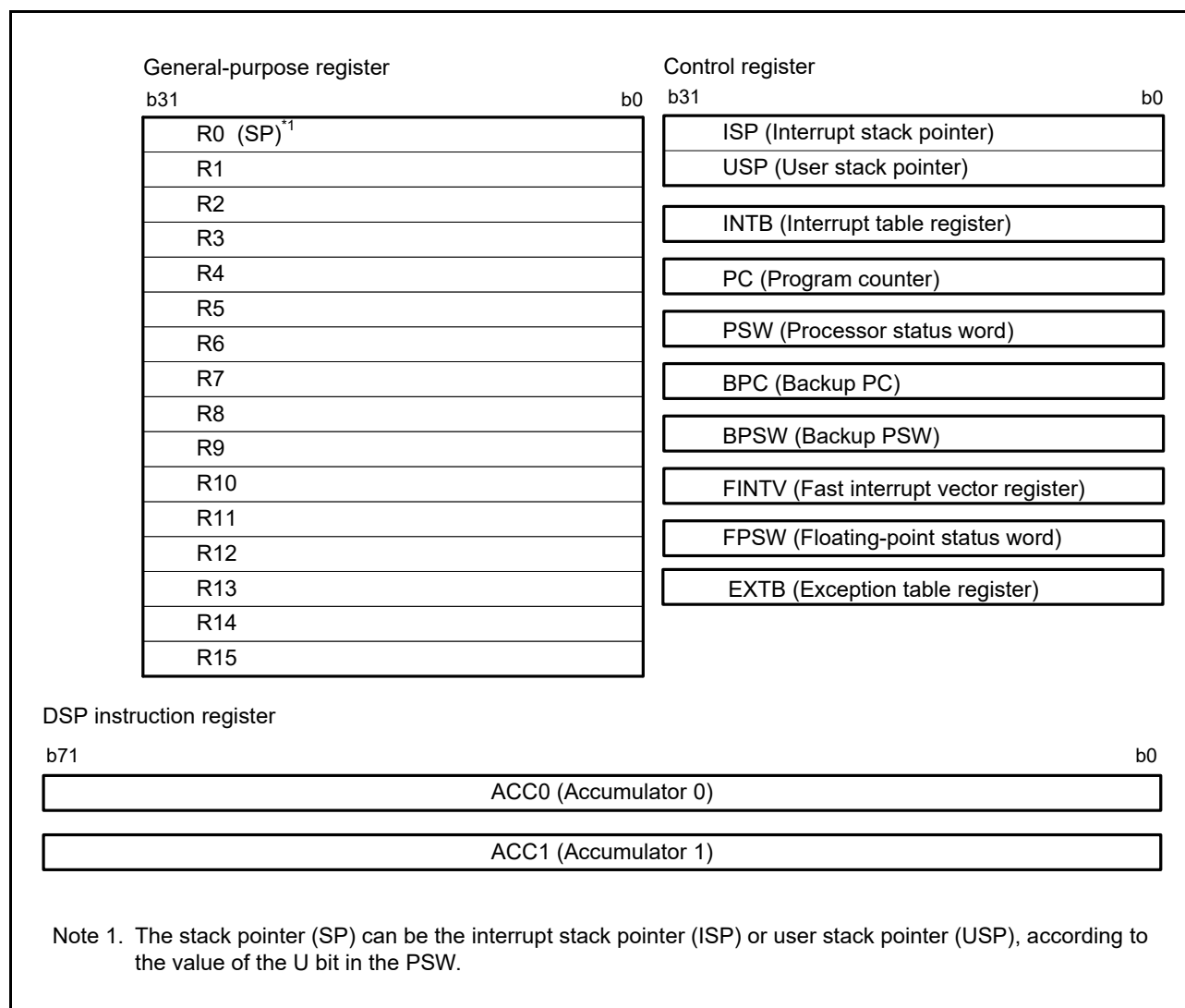


Figure 2.1 Register Set of the CPU

Table 4.1 List of I/O Registers (Address Order) (6/33)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles	
						ICLK ≥ PCLK	ICLK < PCLK
0008 8158h	TPU4	Timer General Register A	TGRA	16	16	2 or 3 PCLKB	2 ICLK
0008 815Ah	TPU4	Timer General Register B	TGRB	16	16	2 or 3 PCLKB	2 ICLK
0008 8160h	TPU5	Timer Control Register	TCR	8	8	2 or 3 PCLKB	2 ICLK
0008 8161h	TPU5	Timer Mode Register	TMDR	8	8	2 or 3 PCLKB	2 ICLK
0008 8162h	TPU5	Timer I/O Control Register	TIOR	8	8	2 or 3 PCLKB	2 ICLK
0008 8164h	TPU5	Timer Interrupt Enable Register	TIER	8	8	2 or 3 PCLKB	2 ICLK
0008 8165h	TPU5	Timer Status Register	TSR	8	8	2 or 3 PCLKB	2 ICLK
0008 8166h	TPU5	Timer Counter	TCNT	16	16	2 or 3 PCLKB	2 ICLK
0008 8168h	TPU5	Timer General Register A	TGRA	16	16	2 or 3 PCLKB	2 ICLK
0008 816Ah	TPU5	Timer General Register B	TGRB	16	16	2 or 3 PCLKB	2 ICLK
0008 8200h	TMR0	Timer Control Register	TCR	8	8	2 or 3 PCLKB	2 ICLK
0008 8201h	TMR1	Timer Control Register	TCR	8	8	2 or 3 PCLKB	2 ICLK
0008 8202h	TMR0	Timer Control/Status Register	TCSR	8	8	2 or 3 PCLKB	2 ICLK
0008 8203h	TMR1	Timer Control/Status Register	TCSR	8	8	2 or 3 PCLKB	2 ICLK
0008 8204h	TMR0	Time Constant Register A	TCORA	8	8	2 or 3 PCLKB	2 ICLK
0008 8205h	TMR1	Time Constant Register A	TCORA	8	8*1	2 or 3 PCLKB	2 ICLK
0008 8206h	TMR0	Time Constant Register B	TCORB	8	8	2 or 3 PCLKB	2 ICLK
0008 8207h	TMR1	Time Constant Register B	TCORB	8	8*1	2 or 3 PCLKB	2 ICLK
0008 8208h	TMR0	Timer Counter	TCNT	8	8	2 or 3 PCLKB	2 ICLK
0008 8209h	TMR1	Timer Counter	TCNT	8	8*1	2 or 3 PCLKB	2 ICLK
0008 820Ah	TMR0	Timer Counter Control Register	TCCR	8	8	2 or 3 PCLKB	2 ICLK
0008 820Bh	TMR1	Timer Counter Control Register	TCCR	8	8*1	2 or 3 PCLKB	2 ICLK
0008 820Ch	TMR0	Timer Count Start Register	TCSTR	8	8	2 or 3 PCLKB	2 ICLK
0008 8210h	TMR2	Timer Control Register	TCR	8	8	2 or 3 PCLKB	2 ICLK
0008 8211h	TMR3	Timer Control Register	TCR	8	8	2 or 3 PCLKB	2 ICLK
0008 8212h	TMR2	Timer Control/Status Register	TCSR	8	8	2 or 3 PCLKB	2 ICLK
0008 8213h	TMR3	Timer Control/Status Register	TCSR	8	8	2 or 3 PCLKB	2 ICLK
0008 8214h	TMR2	Time Constant Register A	TCORA	8	8	2 or 3 PCLKB	2 ICLK
0008 8215h	TMR3	Time Constant Register A	TCORA	8	8*1	2 or 3 PCLKB	2 ICLK
0008 8216h	TMR2	Time Constant Register B	TCORB	8	8	2 or 3 PCLKB	2 ICLK
0008 8217h	TMR3	Time Constant Register B	TCORB	8	8*1	2 or 3 PCLKB	2 ICLK
0008 8218h	TMR2	Timer Counter	TCNT	8	8	2 or 3 PCLKB	2 ICLK
0008 8219h	TMR3	Timer Counter	TCNT	8	8*1	2 or 3 PCLKB	2 ICLK
0008 821Ah	TMR2	Timer Counter Control Register	TCCR	8	8	2 or 3 PCLKB	2 ICLK
0008 821Bh	TMR3	Timer Counter Control Register	TCCR	8	8*1	2 or 3 PCLKB	2 ICLK
0008 821Ch	TMR2	Timer Count Start Register	TCSTR	8	8	2 or 3 PCLKB	2 ICLK
0008 8280h	CRC	CRC Control Register	CRCCR	8	8	2 or 3 PCLKB	2 ICLK
0008 8281h	CRC	CRC Data Input Register	CRCDIR	8	8	2 or 3 PCLKB	2 ICLK
0008 8282h	CRC	CRC Data Output Register	CRCDOR	16	16	2 or 3 PCLKB	2 ICLK
0008 8300h	RIIC0	I ² C-Bus Control Register 1	ICCR1	8	8	2 or 3 PCLKB	2 ICLK
0008 8301h	RIIC0	I ² C-Bus Control Register 2	ICCR2	8	8	2 or 3 PCLKB	2 ICLK
0008 8302h	RIIC0	I ² C-Bus Mode Register 1	ICMR1	8	8	2 or 3 PCLKB	2 ICLK
0008 8303h	RIIC0	I ² C-Bus Mode Register 2	ICMR2	8	8	2 or 3 PCLKB	2 ICLK
0008 8304h	RIIC0	I ² C-Bus Mode Register 3	ICMR3	8	8	2 or 3 PCLKB	2 ICLK
0008 8305h	RIIC0	I ² C-Bus Function Enable Register	ICFER	8	8	2 or 3 PCLKB	2 ICLK
0008 8306h	RIIC0	I ² C-Bus Status Enable Register	ICSER	8	8	2 or 3 PCLKB	2 ICLK
0008 8307h	RIIC0	I ² C-Bus Interrupt Enable Register	ICIER	8	8	2 or 3 PCLKB	2 ICLK
0008 8308h	RIIC0	I ² C-Bus Status Register 1	ICSR1	8	8	2 or 3 PCLKB	2 ICLK
0008 8309h	RIIC0	I ² C-Bus Status Register 2	ICSR2	8	8	2 or 3 PCLKB	2 ICLK
0008 830Ah	RIIC0	Slave Address Register L0	SARL0	8	8	2 or 3 PCLKB	2 ICLK
0008 830Bh	RIIC0	Slave Address Register U0	SARU0	8	8	2 or 3 PCLKB	2 ICLK
0008 830Ch	RIIC0	Slave Address Register L1	SARL1	8	8	2 or 3 PCLKB	2 ICLK

Table 4.1 List of I/O Registers (Address Order) (8/33)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles	
						ICLK ≥ PCLK	ICLK < PCLK
0008 901Eh	S12AD	A/D Self-Diagnosis Data Register	ADDRD	16	16	2 or 3 PCLKB	2 ICLK
0008 9020h	S12AD	A/D Data Register 0	ADDR0	16	16	2 or 3 PCLKB	2 ICLK
0008 9022h	S12AD	A/D Data Register 1	ADDR1	16	16	2 or 3 PCLKB	2 ICLK
0008 9024h	S12AD	A/D Data Register 2	ADDR2	16	16	2 or 3 PCLKB	2 ICLK
0008 9026h	S12AD	A/D Data Register 3	ADDR3	16	16	2 or 3 PCLKB	2 ICLK
0008 9028h	S12AD	A/D Data Register 4	ADDR4	16	16	2 or 3 PCLKB	2 ICLK
0008 902Ah	S12AD	A/D Data Register 5	ADDR5	16	16	2 or 3 PCLKB	2 ICLK
0008 902Ch	S12AD	A/D Data Register 6	ADDR6	16	16	2 or 3 PCLKB	2 ICLK
0008 902Eh	S12AD	A/D Data Register 7	ADDR7	16	16	2 or 3 PCLKB	2 ICLK
0008 9040h	S12AD	A/D Data Register 16	ADDR16	16	16	2 or 3 PCLKB	2 ICLK
0008 9042h	S12AD	A/D Data Register 17	ADDR17	16	16	2 or 3 PCLKB	2 ICLK
0008 9044h	S12AD	A/D Data Register 18	ADDR18	16	16	2 or 3 PCLKB	2 ICLK
0008 9046h	S12AD	A/D Data Register 19	ADDR19	16	16	2 or 3 PCLKB	2 ICLK
0008 9048h	S12AD	A/D Data Register 20	ADDR20	16	16	2 or 3 PCLKB	2 ICLK
0008 904Ah	S12AD	A/D Data Register 21	ADDR21	16	16	2 or 3 PCLKB	2 ICLK
0008 904Ch	S12AD	A/D Data Register 22	ADDR22	16	16	2 or 3 PCLKB	2 ICLK
0008 904Eh	S12AD	A/D Data Register 23	ADDR23	16	16	2 or 3 PCLKB	2 ICLK
0008 9050h	S12AD	A/D Data Register 24	ADDR24	16	16	2 or 3 PCLKB	2 ICLK
0008 9052h	S12AD	A/D Data Register 25	ADDR25	16	16	2 or 3 PCLKB	2 ICLK
0008 9055h	S12AD	A/D Data Register 26	ADDR26	16	16	2 or 3 PCLKB	2 ICLK
0008 9056h	S12AD	A/D Data Register 27	ADDR27	16	16	2 or 3 PCLKB	2 ICLK
0008 9058h	S12AD	A/D Data Register 28	ADDR28	16	16	2 or 3 PCLKB	2 ICLK
0008 905Ah	S12AD	A/D Data Register 29	ADDR29	16	16	2 or 3 PCLKB	2 ICLK
0008 905Ch	S12AD	A/D Data Register 30	ADDR30	16	16	2 or 3 PCLKB	2 ICLK
0008 905Eh	S12AD	A/D Data Register 31	ADDR31	16	16	2 or 3 PCLKB	2 ICLK
0008 907Ah	S12AD	A/D Disconnection Detection Control Register	ADDISCR	8	8	2 or 3 PCLKB	2 ICLK
0008 907Dh	S12AD	A/D Event Link Control Register	ADELCCR	8	8	2 or 3 PCLKB	2 ICLK
0008 9080h	S12AD	A/D Group Scan Priority Control Register	ADGSPCR	16	16	2 or 3 PCLKB	2 ICLK
0008 908Ah	S12AD	A/D High-Side/Low-Side Reference Voltage Control Register	ADHVREFCNT	8	8	2 or 3 PCLKB	2 ICLK
0008 908Ch	S12AD	A/D Compare Function Window A/B Status Monitor Register	ADWINMON	8	8	2 or 3 PCLKB	2 ICLK
0008 9090h	S12AD	A/D Compare Function Control Register	ADCMPCR	16	16	2 or 3 PCLKB	2 ICLK
0008 9092h	S12AD	A/D Compare Function Window A Extended Input Select Register	ADCMPSER	8	8	2 or 3 PCLKB	2 ICLK
0008 9093h	S12AD	A/D Compare Function Window A Extended Input Comparison Condition Setting Register	ADCMPLER	8	8	2 or 3 PCLKB	2 ICLK
0008 9094h	S12AD	A/D Compare Function Window A Channel Select Register 0	ADCMPSR0	16	16	2 or 3 PCLKB	2 ICLK
0008 9096h	S12AD	A/D Compare Function Window A Channel Select Register 1	ADCMPSR1	16	16	2 or 3 PCLKB	2 ICLK
0008 9098h	S12AD	A/D Compare Function Window A Comparison Condition Setting Register 0	ADCMPLR0	16	16	2 or 3 PCLKB	2 ICLK
0008 909Ah	S12AD	A/D Compare Function Window A Comparison Condition Setting Register 1	ADCMPLR1	16	16	2 or 3 PCLKB	2 ICLK
0008 909Ch	S12AD	A/D Compare Function Window A Lower-Side Level Setting Register	ADCMPSR0	16	16	2 or 3 PCLKB	2 ICLK
0008 909Eh	S12AD	A/D Compare Function Window A Upper-Side Level Setting Register	ADCMPSR1	16	16	2 or 3 PCLKB	2 ICLK
0008 90A0h	S12AD	A/D Compare Function Window A Channel Status Register 0	ADCMPSR0	16	16	2 or 3 PCLKB	2 ICLK
0008 90A2h	S12AD	A/D Compare Function Window A Channel Status Register 1	ADCMPSR1	16	16	2 or 3 PCLKB	2 ICLK
0008 90A4h	S12AD	A/D Compare Function Window A Extended Input Channel Status Register	ADCMPSER	16	16	2 or 3 PCLKB	2 ICLK
0008 90A6h	S12AD	A/D Compare Function Window B Channel Select Register	ADCMPSNR	8	8	2 or 3 PCLKB	2 ICLK
0008 90A8h	S12AD	A/D Compare Function Window B Lower-Side Level Setting Register	ADWINLLB	16	16	2 or 3 PCLKB	2 ICLK

Table 4.1 List of I/O Registers (Address Order) (22/33)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles	
						ICLK ≥ PCLK	ICLK < PCLK
000A 0060h	USB0	DCP Control Register	DCPCTR	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB) ^{*2}
000A 0064h	USB0	Pipe Window Select Register	PIPESEL	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB) ^{*2}
000A 0068h	USB0	Pipe Configuration Register	PIPECFG	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB) ^{*2}
000A 006Ch	USB0	Pipe Maximum Packet Size Register	PIPEMAXP	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB) ^{*2}
000A 006Eh	USB0	Pipe Cycle Control Register	PIPEPERI	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB) ^{*2}
000A 0070h	USB0	PIPE1 Control Register	PIPE1CTR	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB) ^{*2}
000A 0072h	USB0	PIPE2 Control Register	PIPE2CTR	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB) ^{*2}
000A 0074h	USB0	PIPE3 Control Register	PIPE3CTR	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB) ^{*2}
000A 0076h	USB0	PIPE4 Control Register	PIPE4CTR	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB) ^{*2}
000A 0078h	USB0	PIPE5 Control Register	PIPE5CTR	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB) ^{*2}
000A 007Ah	USB0	PIPE6 Control Register	PIPE6CTR	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB) ^{*2}
000A 007Ch	USB0	PIPE7 Control Register	PIPE7CTR	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB) ^{*2}
000A 007Eh	USB0	PIPE8 Control Register	PIPE8CTR	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB) ^{*2}
000A 0080h	USB0	PIPE9 Control Register	PIPE9CTR	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB) ^{*2}
000A 0090h	USB0	PIPE1 Transaction Counter Enable Register	PIPE1TRE	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB) ^{*2}
000A 0092h	USB0	PIPE1 Transaction Counter Register	PIPE1TRN	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB) ^{*2}
000A 0094h	USB0	PIPE2 Transaction Counter Enable Register	PIPE2TRE	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB) ^{*2}
000A 0096h	USB0	PIPE2 Transaction Counter Register	PIPE2TRN	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB) ^{*2}
000A 0098h	USB0	PIPE3 Transaction Counter Enable Register	PIPE3TRE	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB) ^{*2}
000A 009Ah	USB0	PIPE3 Transaction Counter Register	PIPE3TRN	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB) ^{*2}
000A 009Ch	USB0	PIPE4 Transaction Counter Enable Register	PIPE4TRE	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB) ^{*2}
000A 009Eh	USB0	PIPE4 Transaction Counter Register	PIPE4TRN	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB) ^{*2}
000A 00A0h	USB0	PIPE5 Transaction Counter Enable Register	PIPE5TRE	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB) ^{*2}
000A 00A2h	USB0	PIPE5 Transaction Counter Register	PIPE5TRN	16	16	9 PCLKB or more	Frequency with 1 + 9 × (frequency ratio of ICLK/PCLKB) ^{*2}

Table 4.1 List of I/O Registers (Address Order) (27/33)

Address	Module Symbol	Register Name	Register Symbol	Number of Bits	Access Size	Number of Access Cycles	
						ICLK ≥ PCLK	ICLK < PCLK
000A 8412h	RSCAN	Receive Rule Entry Register 9BH	GAFLMH9	16	16	2 or 3 PCLKB	2 ICLK
000A 8412h	RSCAN	Receive Buffer Register 7AH	RMIDH7	16	16	2 or 3 PCLKB	2 ICLK
000A 8414h	RSCAN	Receive Rule Entry Register 9CL	GAFLPL9	16	16	2 or 3 PCLKB	2 ICLK
000A 8414h	RSCAN	Receive Buffer Register 7BL	RMTS7	16	16	2 or 3 PCLKB	2 ICLK
000A 8416h	RSCAN	Receive Rule Entry Register 9CH	GAFLPH9	16	16	2 or 3 PCLKB	2 ICLK
000A 8416h	RSCAN	Receive Buffer Register 7BH	RMPTR7	16	16	2 or 3 PCLKB	2 ICLK
000A 8418h	RSCAN	Receive Rule Entry Register 10AL	GAFLIDL10	16	16	2 or 3 PCLKB	2 ICLK
000A 8418h	RSCAN	Receive Buffer Register 7CL	RMDF07	16	16	2 or 3 PCLKB	2 ICLK
000A 841Ah	RSCAN	Receive Rule Entry Register 10AH	GAFLIDH10	16	16	2 or 3 PCLKB	2 ICLK
000A 841Ah	RSCAN	Receive Buffer Register 7CH	RMDF17	16	16	2 or 3 PCLKB	2 ICLK
000A 841Ch	RSCAN	Receive Rule Entry Register 10BL	GAFLML10	16	16	2 or 3 PCLKB	2 ICLK
000A 841Ch	RSCAN	Receive Buffer Register 7DL	RMDF27	16	16	2 or 3 PCLKB	2 ICLK
000A 841Eh	RSCAN	Receive Rule Entry Register 10BH	GAFLMH10	16	16	2 or 3 PCLKB	2 ICLK
000A 841Eh	RSCAN	Receive Buffer Register 7DH	RMDF37	16	16	2 or 3 PCLKB	2 ICLK
000A 8420h	RSCAN	Receive Rule Entry Register 10CL	GAFLPL10	16	16	2 or 3 PCLKB	2 ICLK
000A 8420h	RSCAN	Receive Buffer Register 8AL	RMIDL8	16	16	2 or 3 PCLKB	2 ICLK
000A 8422h	RSCAN	Receive Rule Entry Register 10CH	GAFLPH10	16	16	2 or 3 PCLKB	2 ICLK
000A 8422h	RSCAN	Receive Buffer Register 8AH	RMIDH8	16	16	2 or 3 PCLKB	2 ICLK
000A 8424h	RSCAN	Receive Rule Entry Register 11AL	GAFLIDL11	16	16	2 or 3 PCLKB	2 ICLK
000A 8424h	RSCAN	Receive Buffer Register 8BL	RMTS8	16	16	2 or 3 PCLKB	2 ICLK
000A 8426h	RSCAN	Receive Rule Entry Register 11AH	GAFLIDH11	16	16	2 or 3 PCLKB	2 ICLK
000A 8426h	RSCAN	Receive Buffer Register 8BH	RMPTR8	16	16	2 or 3 PCLKB	2 ICLK
000A 8428h	RSCAN	Receive Rule Entry Register 11BL	GAFLML11	16	16	2 or 3 PCLKB	2 ICLK
000A 8428h	RSCAN	Receive Buffer Register 8CL	RMDF08	16	16	2 or 3 PCLKB	2 ICLK
000A 842Ah	RSCAN	Receive Rule Entry Register 11BH	GAFLMH11	16	16	2 or 3 PCLKB	2 ICLK
000A 842Ah	RSCAN	Receive Buffer Register 8CH	RMDF18	16	16	2 or 3 PCLKB	2 ICLK
000A 842Ch	RSCAN	Receive Rule Entry Register 11CL	GAFLPL11	16	16	2 or 3 PCLKB	2 ICLK
000A 842Ch	RSCAN	Receive Buffer Register 8DL	RMDF28	16	16	2 or 3 PCLKB	2 ICLK
000A 842Eh	RSCAN	Receive Rule Entry Register 11CH	GAFLPH11	16	16	2 or 3 PCLKB	2 ICLK
000A 842Eh	RSCAN	Receive Buffer Register 8DH	RMDF38	16	16	2 or 3 PCLKB	2 ICLK
000A 8430h	RSCAN	Receive Rule Entry Register 12AL	GAFLIDL12	16	16	2 or 3 PCLKB	2 ICLK
000A 8430h	RSCAN	Receive Buffer Register 9AL	RMIDL9	16	16	2 or 3 PCLKB	2 ICLK
000A 8432h	RSCAN	Receive Rule Entry Register 12AH	GAFLIDH12	16	16	2 or 3 PCLKB	2 ICLK
000A 8432h	RSCAN	Receive Buffer Register 9AH	RMIDH9	16	16	2 or 3 PCLKB	2 ICLK
000A 8434h	RSCAN	Receive Rule Entry Register 12BL	GAFLML12	16	16	2 or 3 PCLKB	2 ICLK
000A 8434h	RSCAN	Receive Buffer Register 9BL	RMTS9	16	16	2 or 3 PCLKB	2 ICLK
000A 8436h	RSCAN	Receive Rule Entry Register 12BH	GAFLMH12	16	16	2 or 3 PCLKB	2 ICLK
000A 8436h	RSCAN	Receive Buffer Register 9BH	RMPTR9	16	16	2 or 3 PCLKB	2 ICLK
000A 8438h	RSCAN	Receive Rule Entry Register 12CL	GAFLPL12	16	16	2 or 3 PCLKB	2 ICLK
000A 8438h	RSCAN	Receive Buffer Register 9CL	RMDF09	16	16	2 or 3 PCLKB	2 ICLK
000A 843Ah	RSCAN	Receive Rule Entry Register 12CH	GAFLPH12	16	16	2 or 3 PCLKB	2 ICLK
000A 843Ah	RSCAN	Receive Buffer Register 9CH	RMDF19	16	16	2 or 3 PCLKB	2 ICLK
000A 843Ch	RSCAN	Receive Rule Entry Register 13AL	GAFLIDL13	16	16	2 or 3 PCLKB	2 ICLK
000A 843Ch	RSCAN	Receive Buffer Register 9DL	RMDF29	16	16	2 or 3 PCLKB	2 ICLK
000A 843Eh	RSCAN	Receive Rule Entry Register 13AH	GAFLIDH13	16	16	2 or 3 PCLKB	2 ICLK
000A 843Eh	RSCAN	Receive Buffer Register 9DH	RMDF39	16	16	2 or 3 PCLKB	2 ICLK
000A 8440h	RSCAN	Receive Rule Entry Register 13BL	GAFLML13	16	16	2 or 3 PCLKB	2 ICLK
000A 8440h	RSCAN	Receive Buffer Register 10AL	RMIDL10	16	16	2 or 3 PCLKB	2 ICLK
000A 8442h	RSCAN	Receive Rule Entry Register 13BH	GAFLMH13	16	16	2 or 3 PCLKB	2 ICLK
000A 8442h	RSCAN	Receive Buffer Register 10AH	RMIDH10	16	16	2 or 3 PCLKB	2 ICLK
000A 8444h	RSCAN	Receive Rule Entry Register 13CL	GAFLPL13	16	16	2 or 3 PCLKB	2 ICLK
000A 8444h	RSCAN	Receive Buffer Register 10BL	RMTS10	16	16	2 or 3 PCLKB	2 ICLK

Table 5.17 Permissible Output Currents (2)Conditions: $1.8\text{ V} \leq VCC = VCC_USB = AVCC0 \leq 5.5\text{ V}$, $VSS = AVSS0 = VSS_USB = 0\text{ V}$, $T_a = -40\text{ to }+105^\circ\text{C}$

Item			Symbol	Max.	Unit
Permissible output low current (average value per pin)	Ports 40 to 47, ports 03, 05, 07, port 36, 37		I _{OL}	4.0	mA
	Ports other than above	Normal output mode		4.0	
		High-drive output mode		8.0	
Permissible output low current (maximum value per pin)	Ports 40 to 47, ports 03, 05, 07, ports 36, 37			4.0	
	Ports other than above	Normal output mode		4.0	
		High-drive output mode		8.0	
Permissible output low current	Total of ports 40 to 47, ports 03, 05, 07		ΣI _{OL}	30	
	Total of ports 12 to 17, ports 20 to 27, ports 30 to 37, port PJ3			30	
	Total of ports 50 to 55, ports C0 to C7, ports B0 to B7			30	
	Total of ports E0 to E7, ports A0 to A7, ports D0 to D4			30	
	Total of all output pins			60	
Permissible output high current (average value per pin)	Ports 40 to 47, ports 03, 05, 07, ports 36, 37		I _{OH}	−4.0	
	Ports other than above	Normal output mode		−4.0	
		High-drive output mode		−8.0	
Permissible output high current (maximum value per pin)	Ports 40 to 47, ports 03, 05, 07, ports 36, 37			−4.0	
	Ports other than above	Normal output mode		−4.0	
		High-drive output mode		−8.0	
Permissible output high current	Total of ports 40 to 47, ports 03, 05, 07		ΣI _{OH}	−30	
	Total of ports 12 to 17, ports 20 to 27, ports 30 to 37, port PJ3			−30	
	Total of ports 50 to 55, ports C0 to C7, ports B0 to B7			−30	
	Total of ports E0 to E7, ports A0 to A7, ports D0 to D4			−30	
	Total of all output pins			−60	

Note: Do not exceed the permissible total supply current.

5.2.1 Normal I/O Pin Output Characteristics (1)

Figure 5.8 to Figure 5.12 show the characteristics when normal output is selected by the drive capacity control register.

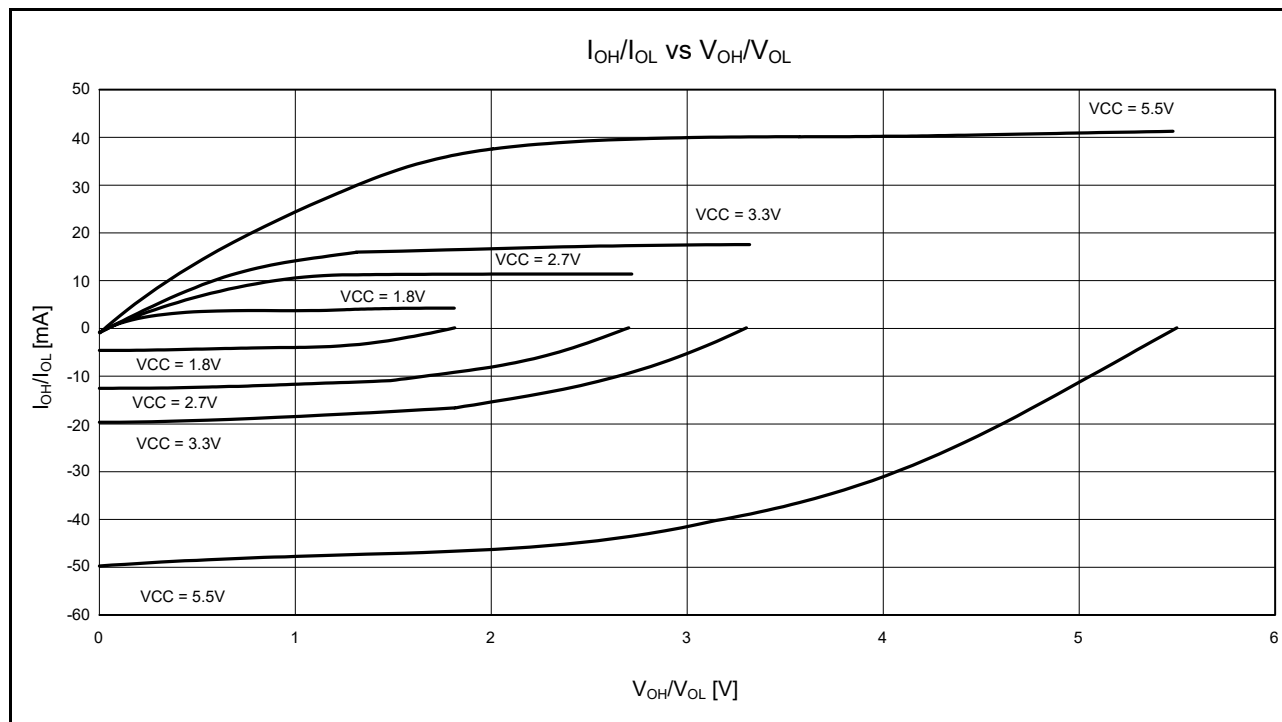


Figure 5.8 V_{OH}/V_{OL} and I_{OH}/I_{OL} Voltage Characteristics at $T_a = 25^\circ\text{C}$ When Normal Output is Selected (Reference Data)

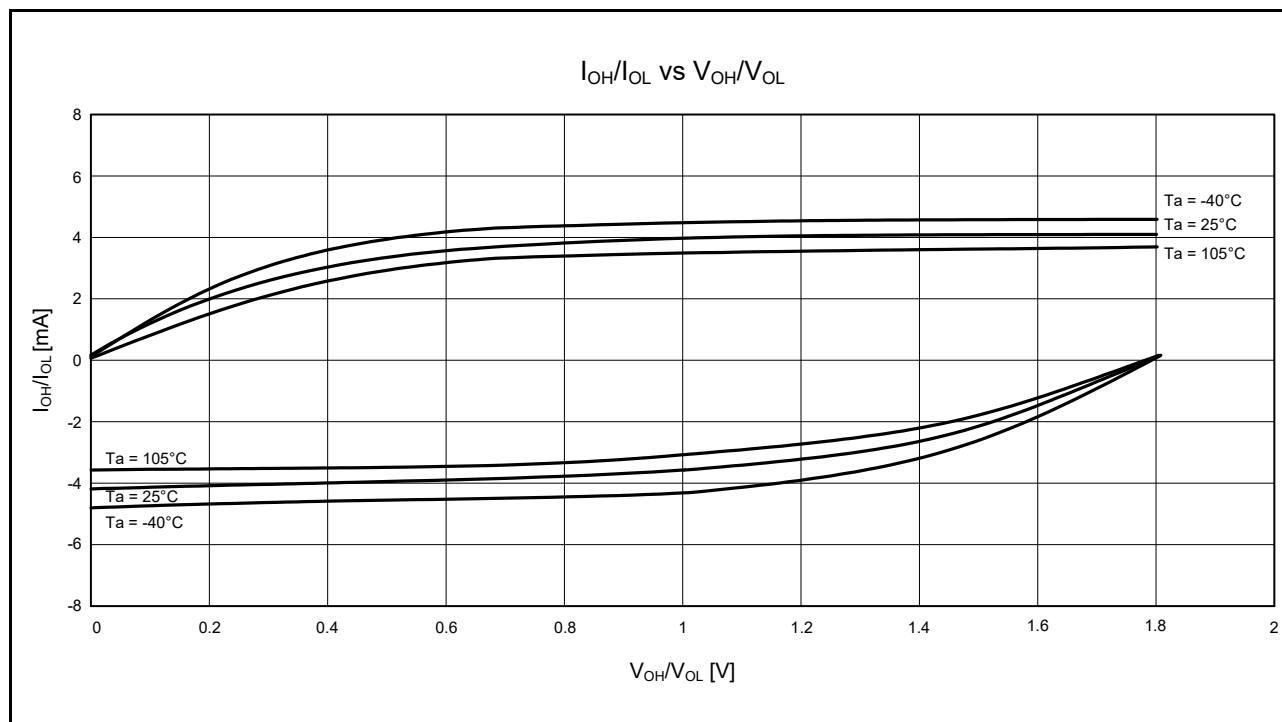


Figure 5.9 V_{OH}/V_{OL} and I_{OH}/I_{OL} Temperature Characteristics at $V_{CC} = 1.8\text{ V}$ When Normal Output is Selected (Reference Data)

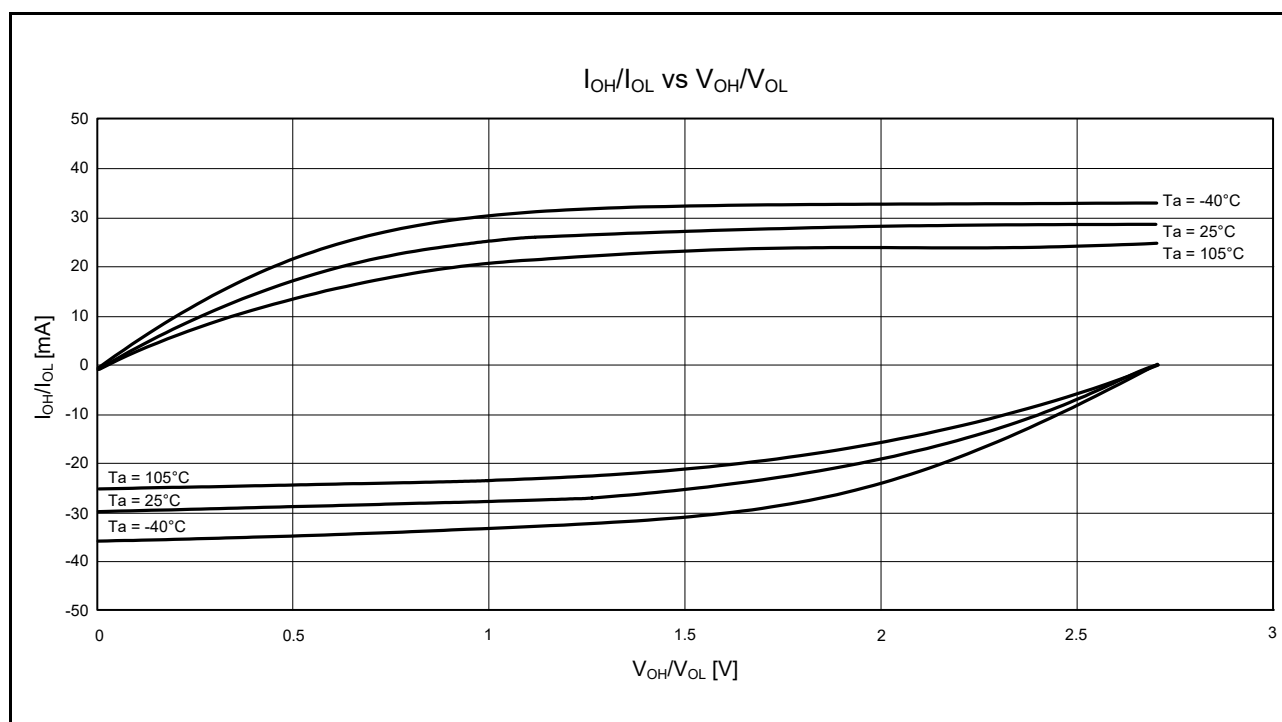


Figure 5.15 V_{OH}/V_{OL} and I_{OH}/I_{OL} Temperature Characteristics at $V_{CC} = 2.7$ V When High-Drive Output is Selected (Reference Data)

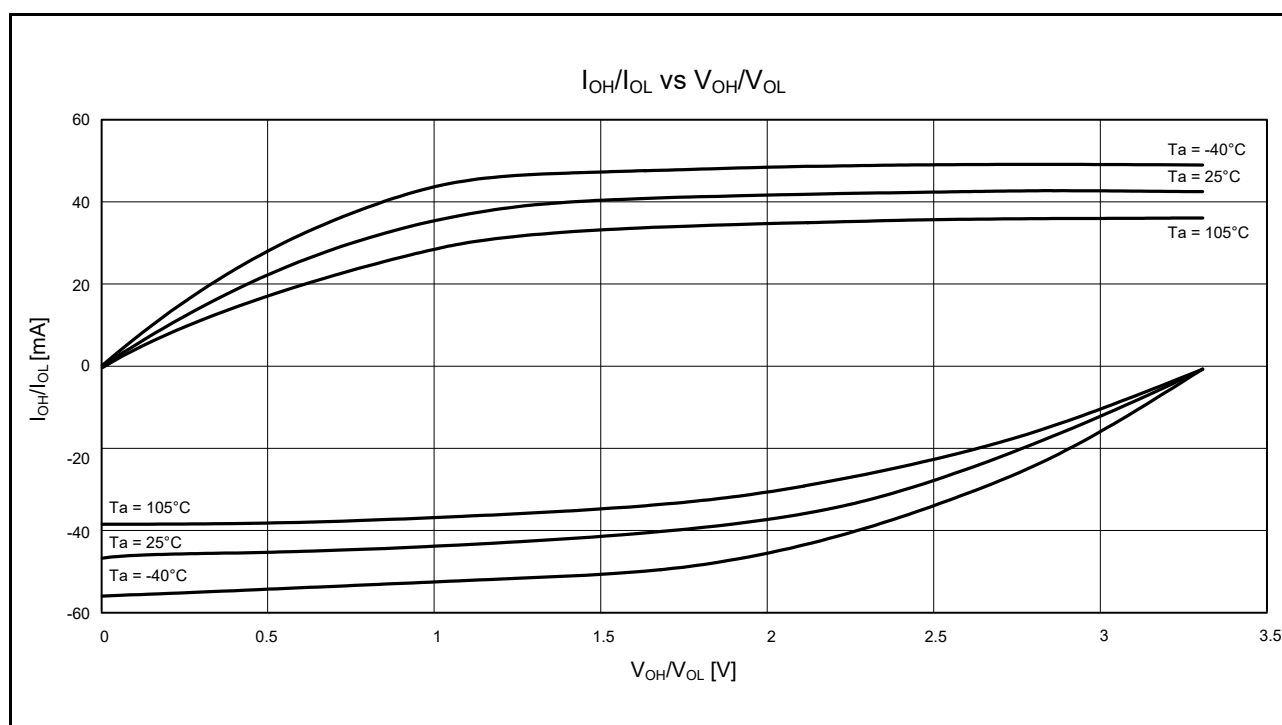


Figure 5.16 V_{OH}/V_{OL} and I_{OH}/I_{OL} Temperature Characteristics at $V_{CC} = 3.3$ V When High-Drive Output is Selected (Reference Data)

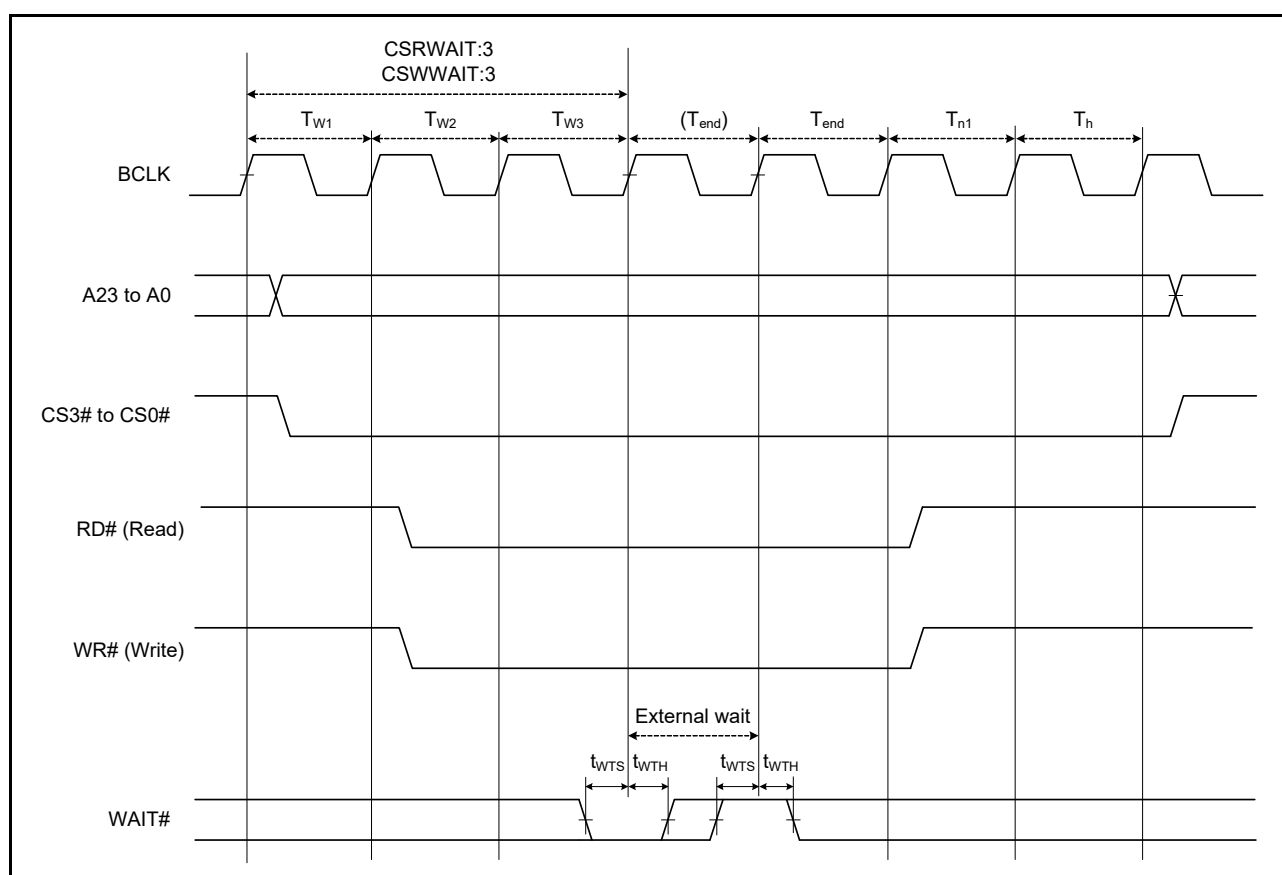


Figure 5.42 External Bus Timing/External Wait Control

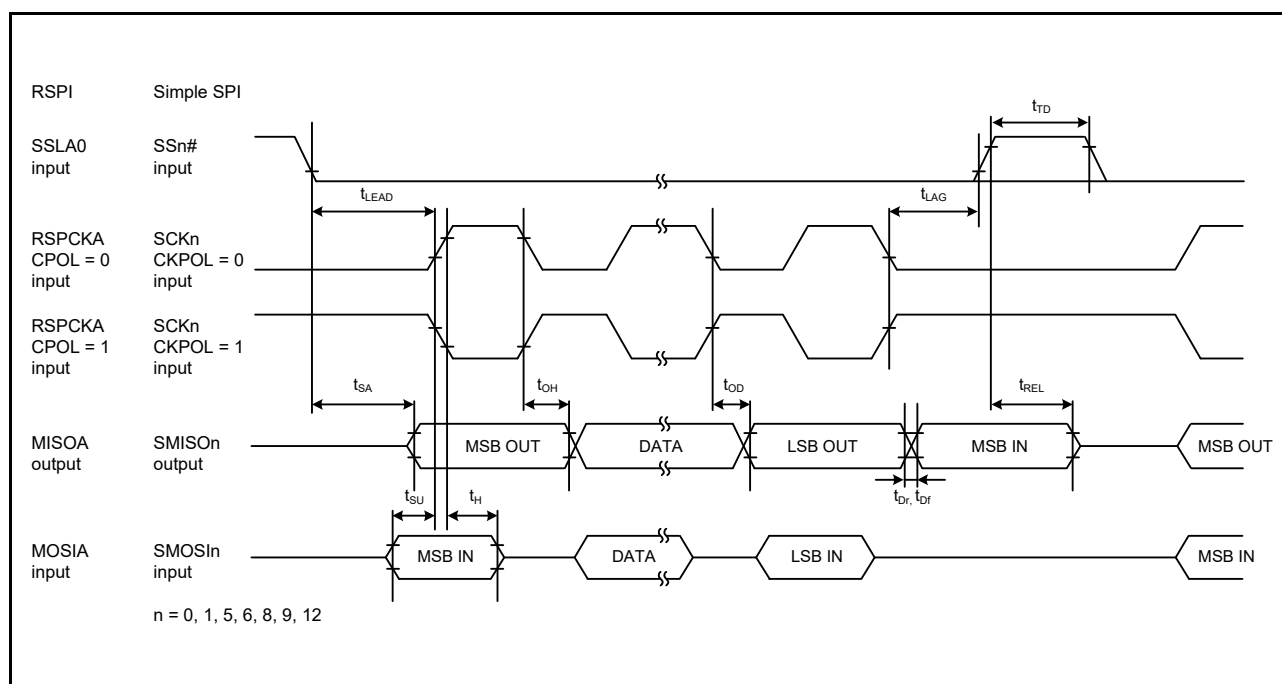


Figure 5.57 RSPI Timing (Slave, CPHA = 0) and Simple SPI Clock Timing (Slave, CKPH = 1)

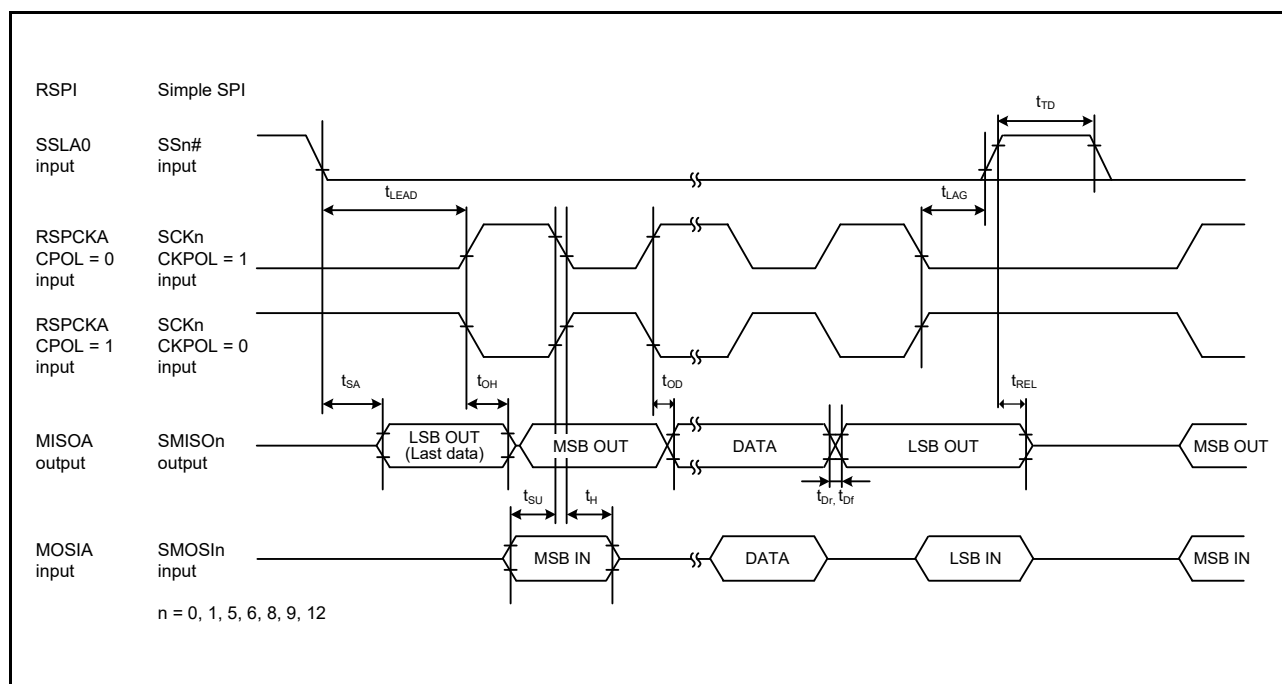


Figure 5.58 RSPI Timing (Slave, CPHA = 1) and Simple SPI Clock Timing (Slave, CKPH = 0)

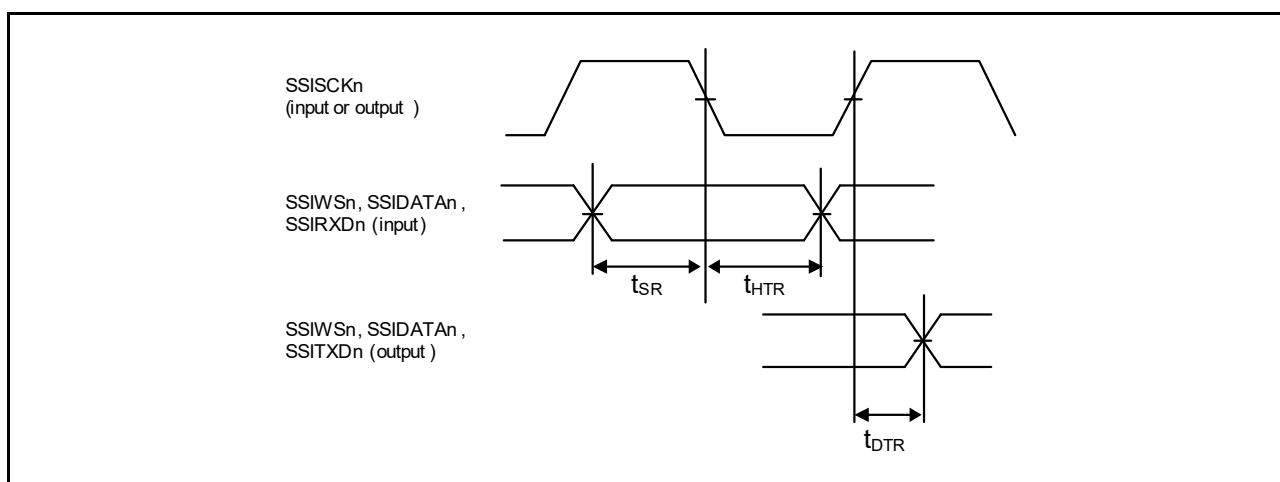


Figure 5.62 SSI Transmission/Reception Timing (SSICR.SCKP=1)

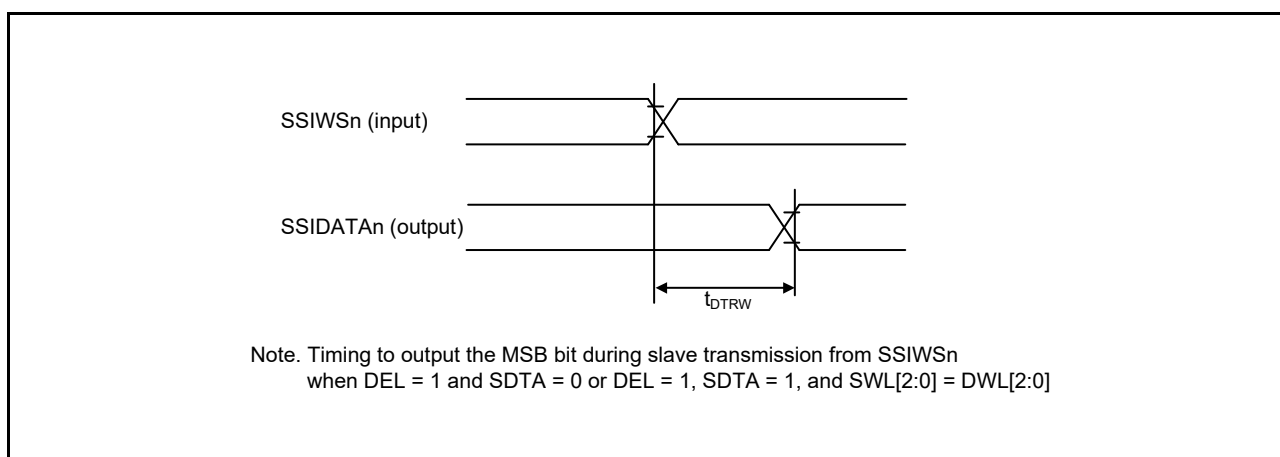


Figure 5.63 SSIDATA Output Delay After SSIWSn Changing Edge

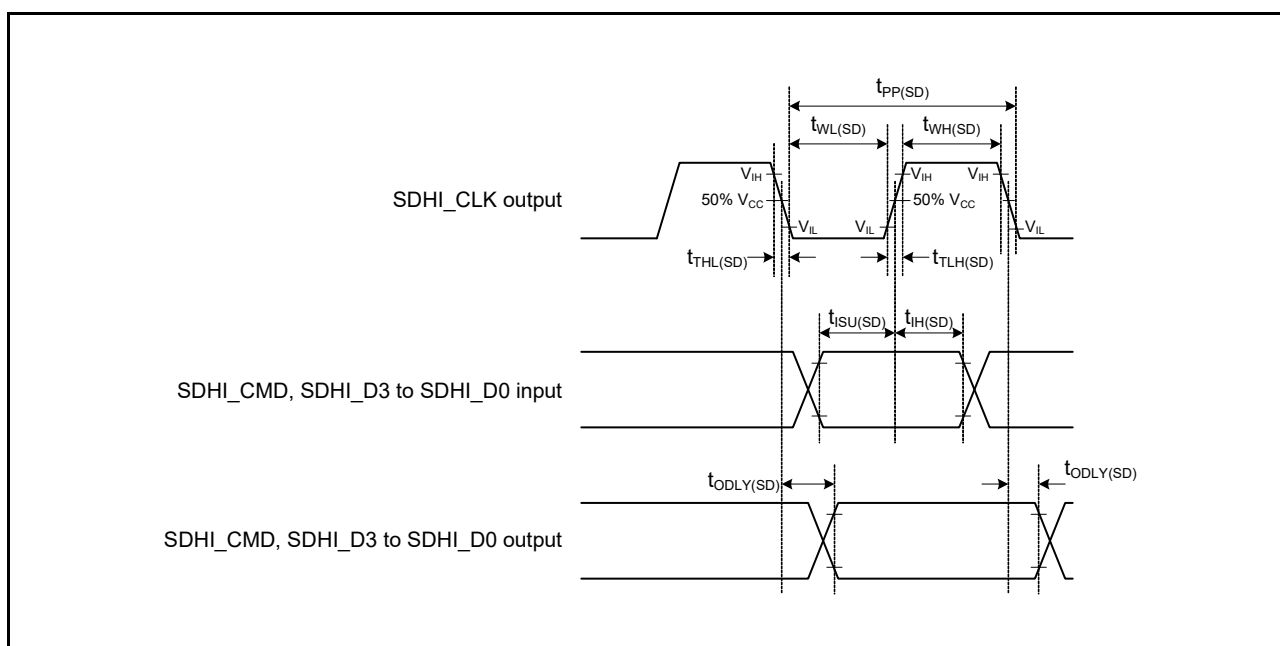


Figure 5.64 SD Host Interface Input/Output Signal Timing

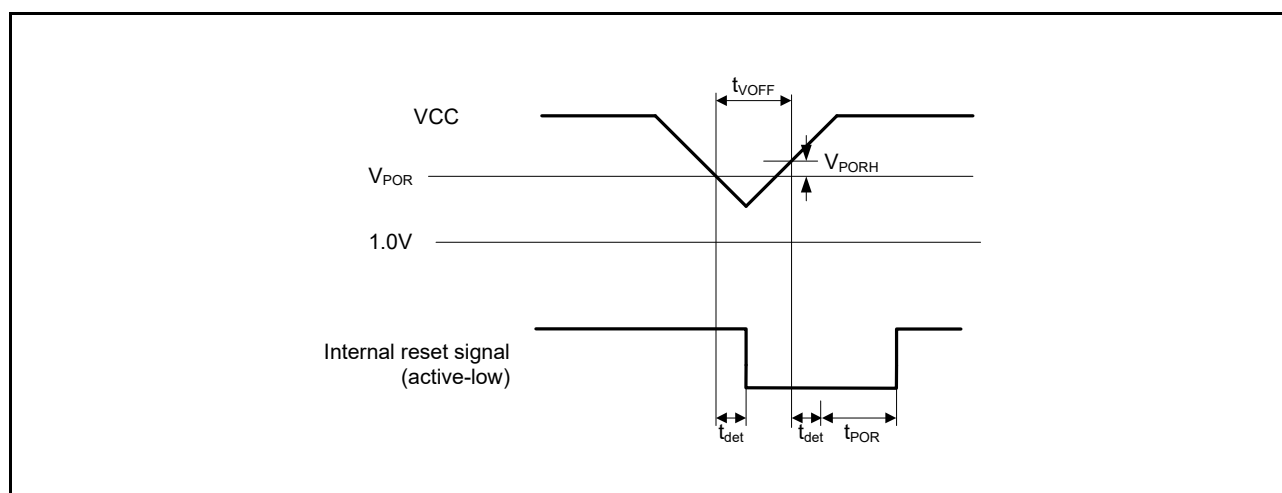


Figure 5.73 Voltage Detection Reset Timing

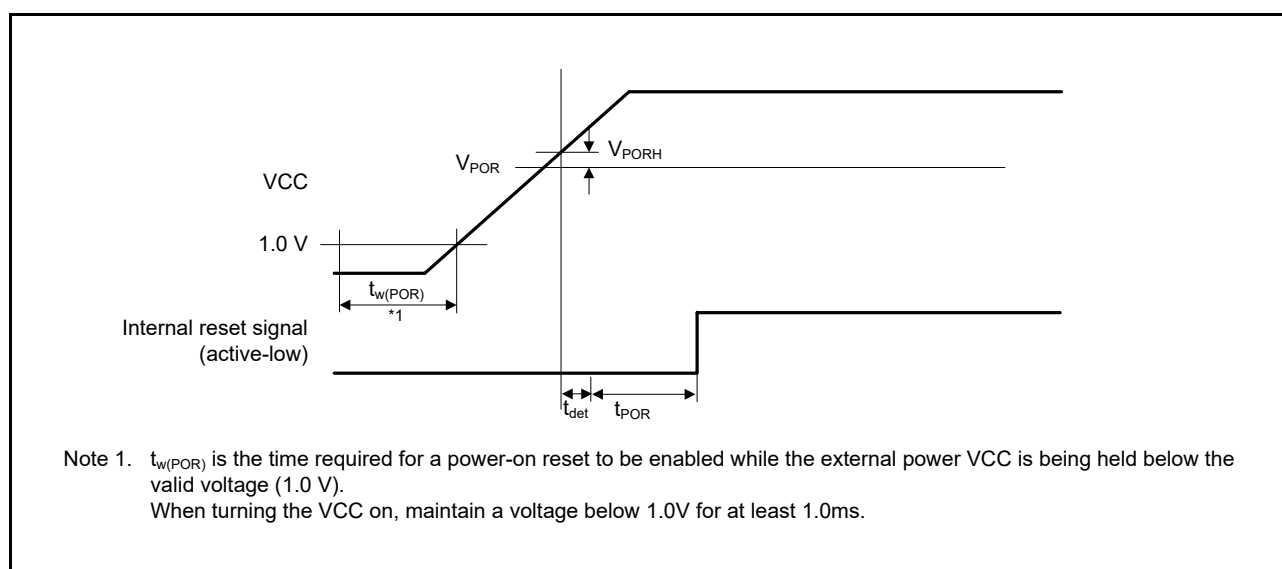


Figure 5.74 Power-On Reset Timing

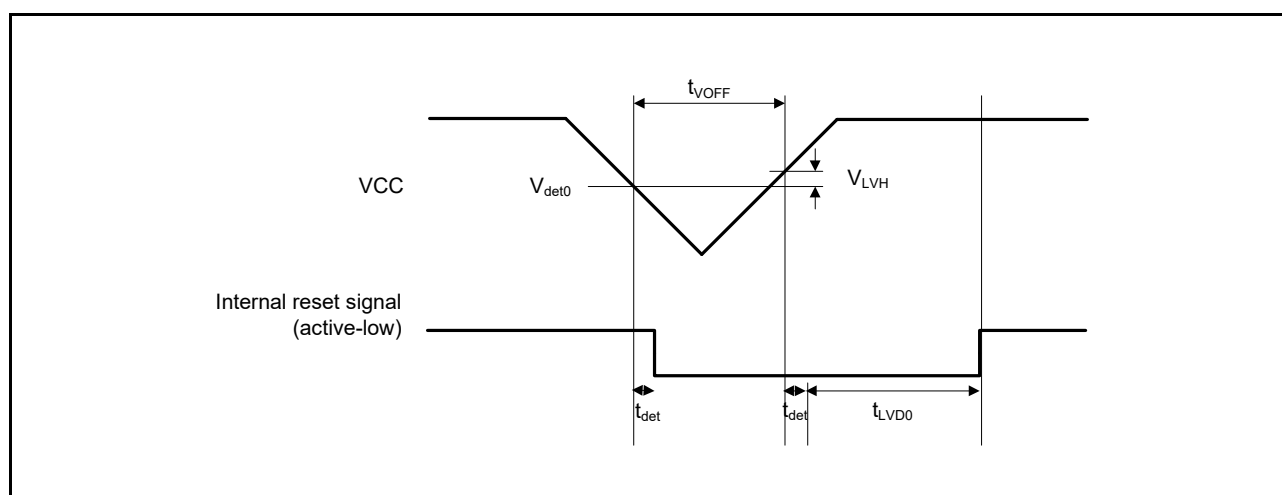
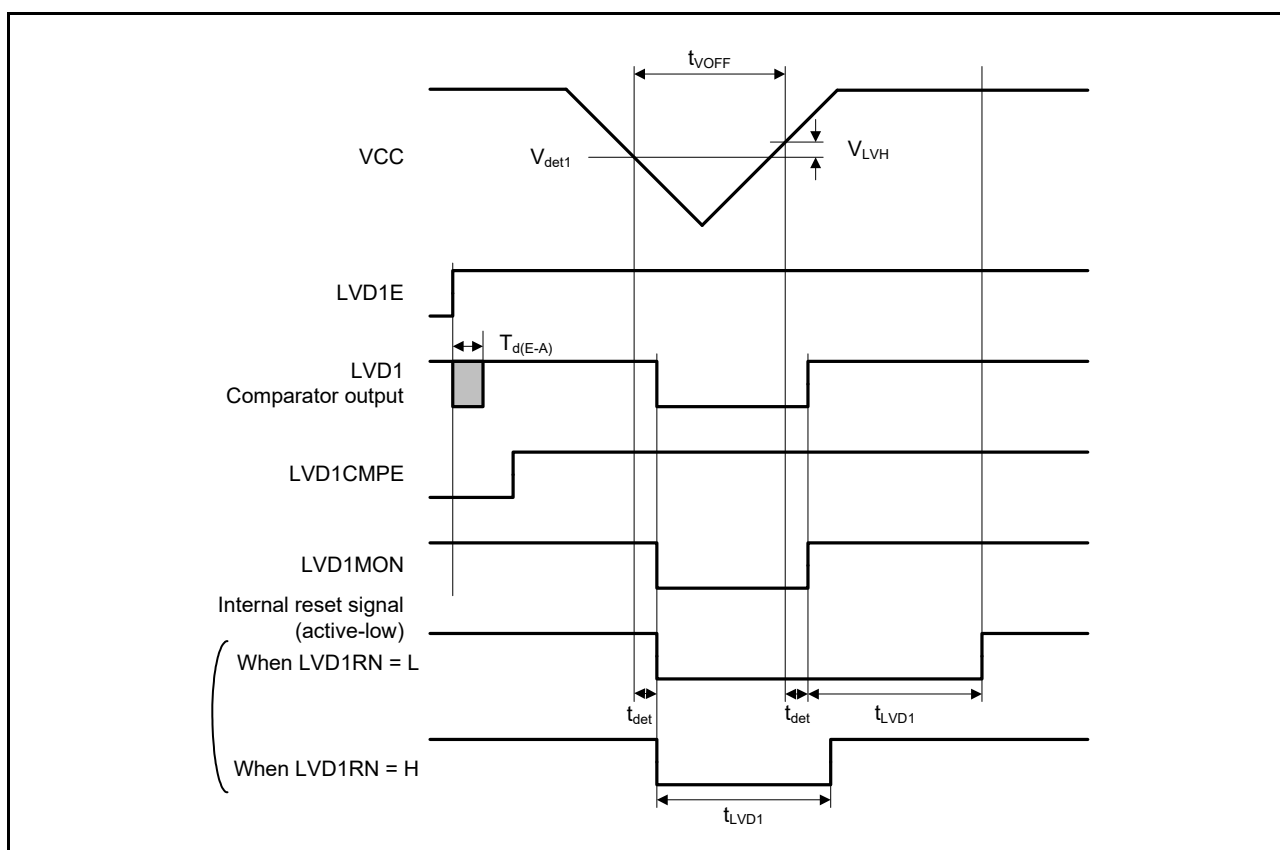
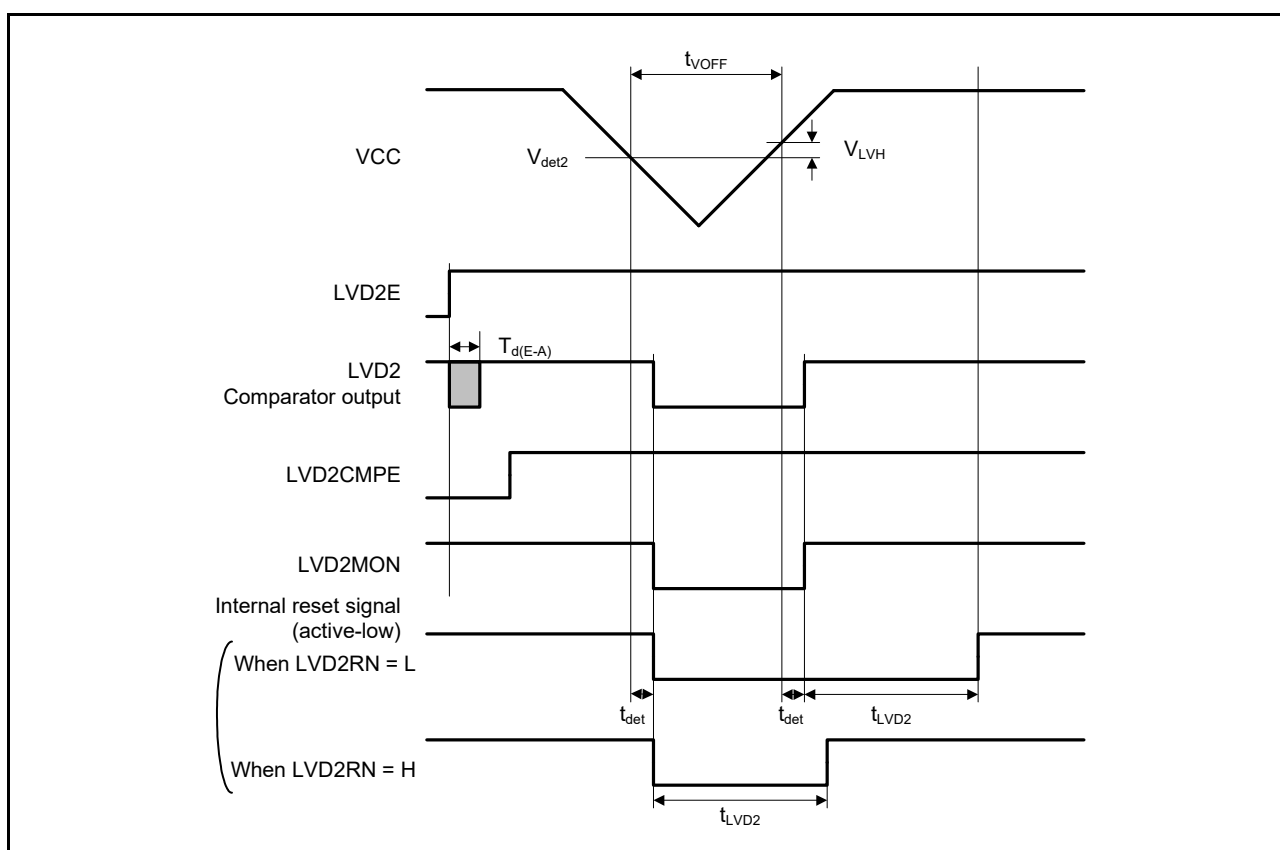


Figure 5.75 Voltage Detection Circuit Timing (Vdet0)

Figure 5.76 Voltage Detection Circuit Timing (V_{det1})Figure 5.77 Voltage Detection Circuit Timing (V_{det2})

5.14 E2 DataFlash Characteristics (Flash Memory for Data Storage)

Table 5.65 E2 DataFlash Characteristics (1)

Item		Symbol	Min.	Typ.	Max.	Unit	Conditions
Reprogramming/erasure cycle*1		N _{DPEC}	100000	1000000	—	Times	
Data hold time	After 10000 times of N _{DPEC}	t _{DDRP}	20*2, *3	—	—	Year	T _a = +85°C
	After 100000 times of N _{DPEC}		5*2, *3	—	—	Year	
	After 1000000 times of N _{DPEC}		—	1*2, *3	—	Year	T _a = +25°C

Note 1. The reprogram/erase cycle is the number of erasing for each block. When the reprogram/erase cycle is n times (n = 100000), erasing can be performed n times for each block. For instance, when 1-byte programming is performed 1000 times for different addresses in a 1-Kbyte block and then the entire block is erased, the reprogram/erase cycle is counted as one. However, programming the same address for several times as one erasing is not enabled (overwriting is prohibited).

Note 2. Characteristic when the flash memory programmer is used and the self-programming library is provided from Renesas Electronics.

Note 3. These results are obtained from reliability testing.

**Table 5.66 E2 DataFlash Characteristics (2)
: high-speed operating mode**

Conditions: 2.7 V ≤ VCC = VCC_USB = AVCC0 ≤ 5.5 V, VSS = AVSS0 = VSS_USB = 0 V

Temperature range for the programming/erasure operation: T_a = -40 to +105°C

Item		Symbol	FCLK = 1 MHz			FCLK = 32 MHz			Unit
			Min.	Typ.	Max.	Min.	Typ.	Max.	
Programming time	1 byte	t _{DP1}	—	95.0	797	—	40.8	376	μs
Erasure time	1 Kbyte	t _{DE1K}	—	19.5	498	—	6.2	230	ms
	8 Kbyte	t _{DE8K}	—	119.8	2556	—	12.9	368	ms
Blank check time	1 byte	t _{DBC1}	—	—	55.00	—	—	16.1	μs
	1 Kbyte	t _{DBC1K}	—	—	0.72	—	—	0.50	ms
Erase operation forced stop time		t _{DSED}	—	—	16.0	—	—	10.7	μs
DataFlash STOP recovery time		t _{DSTOP}	5.0	—	—	5.0	—	—	μs

Note: The time until each operation of the flash memory is started after instructions are executed by software is not included.

Note: The lower-limit frequency of FCLK is 1 MHz during programming or erasing of the flash memory. When using FCLK at below 4 MHz, the frequency can be set to 1 MHz, 2 MHz, or 3 MHz. A non-integer frequency such as 1.5 MHz cannot be set.

Note: The frequency accuracy of FCLK must be within ±3.5%.

**Table 5.67 E2 DataFlash Characteristics (3)
: middle-speed operating mode**

Conditions: 1.8 V ≤ VCC0 = VCC_USB = AVCC0 ≤ 5.5 V, VSS = AVSS0 = VSS_USB = 0 V

Temperature range for the programming/erasure operation: T_a = -40 to +85°C

Item		Symbol	FCLK = 1 MHz			FCLK = 8 MHz			Unit
			Min.	Typ.	Max.	Min.	Typ.	Max.	
Programming time	1 byte	t _{DP1}	—	135	1197	—	86.5	823	μs
Erasure time	1 Kbyte	t _{DE1K}	—	19.6	501	—	8.0	265	ms
	8 Kbyte	t _{DE8K}	—	120	2558	—	27.7	669	ms
Blank check time	1 byte	t _{DBC1}	—	—	85.0	—	—	50.9	μs
	1 Kbyte	t _{DBC1K}	—	—	0.72	—	—	1.45	ms
Erase operation forced stop time		t _{DSED}	—	—	28.0	—	—	21.3	μs
DataFlash STOP recovery time		t _{DSTOP}	0.72	—	—	0.72	—	—	μs

Note: The time until each operation of the flash memory is started after instructions are executed by software is not included.

Note: The lower-limit frequency of FCLK is 1 MHz during programming or erasing of the flash memory. When using FCLK at below 4 MHz, the frequency can be set to 1 MHz, 2 MHz, or 3 MHz. A non-integer frequency such as 1.5 MHz cannot be set.

Note: The frequency accuracy of FCLK must be within ±3.5%.

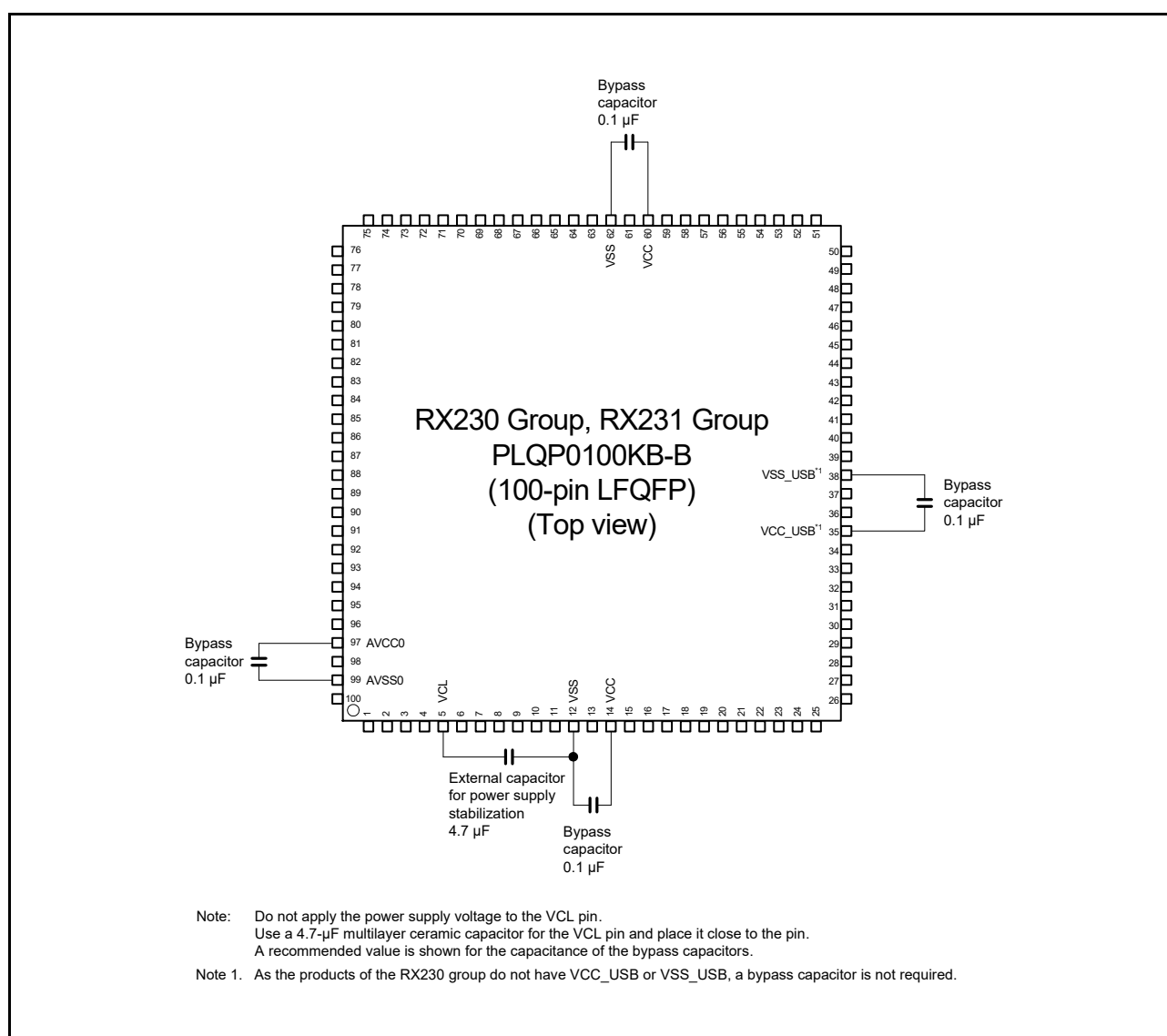
5.15 Usage Notes

5.15.1 Connecting VCL Capacitor and Bypass Capacitors

This MCU integrates an internal voltage-down circuit, which is used for lowering the power supply voltage in the internal MCU automatically to the optimum level. A 4.7- μ F capacitor needs to be connected between this internal voltage-down power supply (VCL pin) and the VSS pin. Figure 5.80 to Figure 5.82 shows how to connect external capacitors. Place an external capacitor close to the pins. Do not apply the power supply voltage to the VCL pin.

Insert a multilayer ceramic capacitor as a bypass capacitor between each pair of the power supply pins. Implement a bypass capacitor as closer to the MCU power supply pins as possible. Use a recommended value of 0.1 μ F as the capacitance of the capacitors. For the capacitors related to crystal oscillation, see section 9, Clock Generation Circuit in the User's Manual: Hardware. For the capacitors related to analog modules, also see section 43, 12-Bit A/D Converter (S12ADE) in the User's Manual: Hardware.

For notes on designing the printed circuit board, see the descriptions of the application note, the Hardware Design Guide (R01AN1411EJ). The latest version can be downloaded from the Renesas Electronics website.

**Figure 5.80 Connecting Capacitors (100 Pins)**

NOTES FOR CMOS DEVICES

- (1) **VOLTAGE APPLICATION WAVEFORM AT INPUT PIN:** Waveform distortion due to input noise or a reflected wave may cause malfunction. If the input of the CMOS device stays in the area between V_{IL} (MAX) and V_{IH} (MIN) due to noise, etc., the device may malfunction. Take care to prevent chattering noise from entering the device when the input level is fixed, and also in the transition period when the input level passes through the area between V_{IL} (MAX) and V_{IH} (MIN).
- (2) **HANDLING OF UNUSED INPUT PINS:** Unconnected CMOS device inputs can be cause of malfunction. If an input pin is unconnected, it is possible that an internal input level may be generated due to noise, etc., causing malfunction. CMOS devices behave differently than Bipolar or NMOS devices. Input levels of CMOS devices must be fixed high or low by using pull-up or pull-down circuitry. Each unused pin should be connected to VDD or GND via a resistor if there is a possibility that it will be an output pin. All handling related to unused pins must be judged separately for each device and according to related specifications governing the device.
- (3) **PRECAUTION AGAINST ESD:** A strong electric field, when exposed to a MOS device, can cause destruction of the gate oxide and ultimately degrade the device operation. Steps must be taken to stop generation of static electricity as much as possible, and quickly dissipate it when it has occurred. Environmental control must be adequate. When it is dry, a humidifier should be used. It is recommended to avoid using insulators that easily build up static electricity. Semiconductor devices must be stored and transported in an anti-static container, static shielding bag or conductive material. All test and measurement tools including work benches and floors should be grounded. The operator should be grounded using a wrist strap. Semiconductor devices must not be touched with bare hands. Similar precautions need to be taken for PW boards with mounted semiconductor devices.
- (4) **STATUS BEFORE INITIALIZATION:** Power-on does not necessarily define the initial status of a MOS device. Immediately after the power source is turned ON, devices with reset functions have not yet been initialized. Hence, power-on does not guarantee output pin levels, I/O settings or contents of registers. A device is not initialized until the reset signal is received. A reset operation must be executed immediately after power-on for devices with reset functions.
- (5) **POWER ON/OFF SEQUENCE:** In the case of a device that uses different power supplies for the internal operation and external interface, as a rule, switch on the external power supply after switching on the internal power supply. When switching the power supply off, as a rule, switch off the external power supply and then the internal power supply. Use of the reverse power on/off sequences may result in the application of an overvoltage to the internal elements of the device, causing malfunction and degradation of internal elements due to the passage of an abnormal current. The correct power on/off sequence must be judged separately for each device and according to related specifications governing the device.
- (6) **INPUT OF SIGNAL DURING POWER OFF STATE :** Do not input signals or an I/O pull-up power supply while the device is not powered. The current injection that results from input of such a signal or I/O pull-up power supply may cause malfunction and the abnormal current that passes in the device at this time may cause degradation of internal elements. Input of signals during the power off state must be judged separately for each device and according to related specifications governing the device.